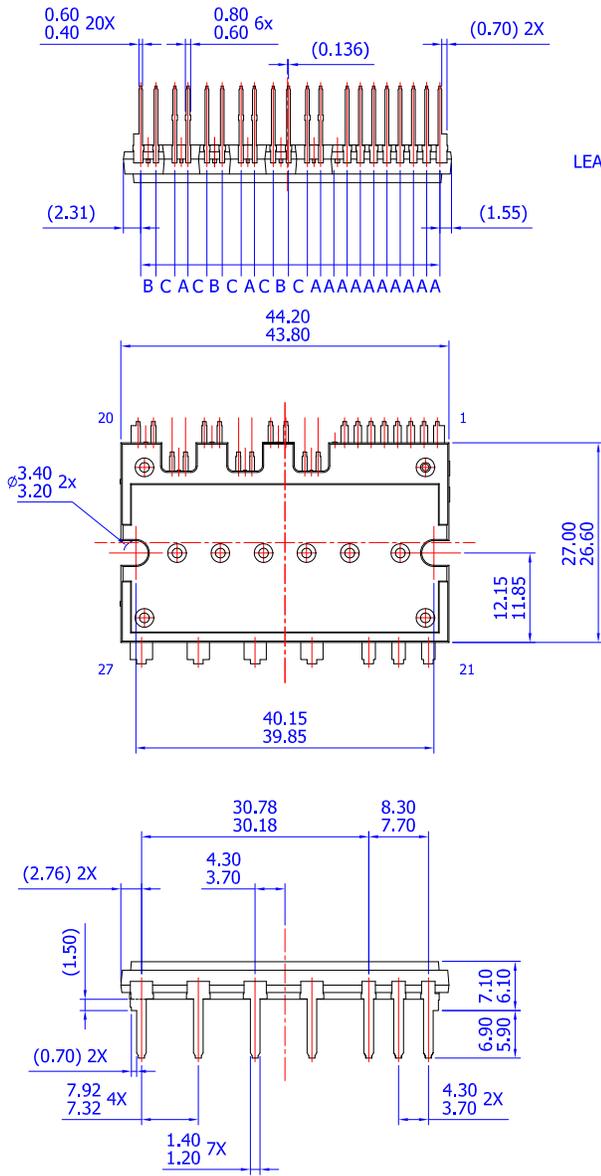
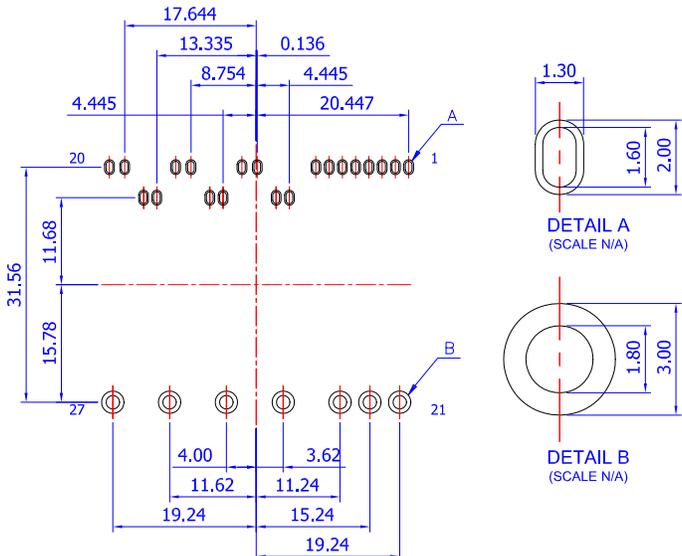
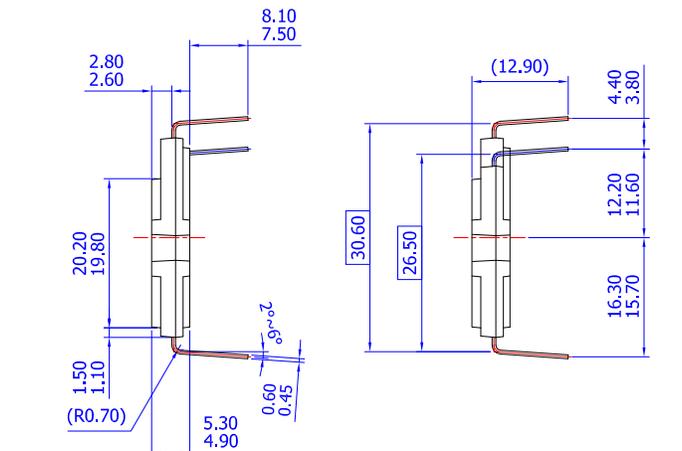


**SPMJA-027 / 27LD, PDD STD, FULL PACK TYPE**  
**CASE MODDP**  
**ISSUE O**

DATE 31 DEC 2016



LEAD PITCH (TOLERANCE : ±0.30)  
A : 1.778  
B : 2.050  
C : 2.531



- NOTES: UNLESS OTHERWISE SPECIFIED  
A) THIS PACKAGE DOES NOT COMPLY TO ANY CURRENT PACKAGING STANDARD  
B) ALL DIMENSIONS ARE IN MILLIMETERS  
C) DIMENSIONS ARE EXCLUSIVE OF BURRS, MOLD FLASH, AND TIE BAR EXTRUSIONS  
D) ( ) IS REFERENCE  
E) [ ] IS ASS'Y QUALITY

**LAND PATTERN RECOMMENDATIONS**

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<b>DESCRIPTION:</b>	<b>SPMJA-027 / 27LD, PDD STD, FULL PACK TYPE</b>	<b>PAGE 1 OF 1</b>

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